



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|------------------|------------------------------------|-----------------|------------------|
| Applicant(s) | Förster et al. | Examiner: | Unassigned |
| Serial No.: | 10/634,606 | Group Art Unit: | Unassigned |
| Confirmation No: | Unassigned | Docket: | 163-29 CIP |
| Filed: | August 5, 2003 | Dated: | October 24, 2003 |
| For: | INTEGRATED FLUID SENSING DEVICE | | |

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

*I hereby certify this correspondence is being deposited
with the United States Postal Service via first class mail
addressed to:*

Commissioner for Patents, P.O. Box 1450,
Alexandria, Virginia 22313-1450
on October 24, 2003

Signed: *Melinda Sheng*

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

In order to fulfill the requirements of candor and good faith set forth in 37 C.F.R.

§1.56, Applicants submit herewith the following Supplemental Information Disclosure

Statement in accordance with the provisions of 37 C.F.R. §1.97 and §1.98.

UNITED STATES PATENTS

| <u>PATENTEE</u> | <u>PATENT NO.</u> | <u>ISSUE DATE</u> |
|------------------------|--------------------------|--------------------------|
| Shimada et al. | 4,986,127 | January 22, 1991 |
| Mosser et al. | 5,187,984 | February 23, 1993 |
| Ugai et al. | 5,259,248 | November 9, 1993 |
| Kalinoski | 5,463,904 | November 7, 1995 |
| Shimada et al. | 5,469,749 | November 28, 1995 |

PATENTEE**PATENT NO.****ISSUE DATE**

Nishino et al.

5,791,369

August 11, 1998

Lechner

5,820,262

October 13, 1998

Loan et al.

5,868,159

February 9, 1999

FOREIGN PATENT DOCUMENTS**COUNTRY****PUBLICATION NO.****PUBLICATION DATE**

Japan

JP 3-18735

January 28, 1991

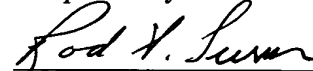
The above-referenced documents are listed on Form PTO-1449. We have enclosed the cited documents to facilitate reference to them.

CONCISE EXPLANATION OF NON-ENGLISH REFERENCES

Japanese reference JP 3-18735 discloses a bi-level detector with sensors mounted within a chamber.

If the Examiner has any questions or comments relating to the present application, he or she is respectfully invited to contact Applicants' attorney at the telephone number set forth below.

Respectfully submitted,

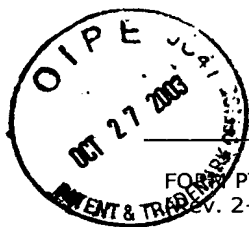


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|---|--------------------------------|--------------------------------|
| FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT & TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) | ATTY. DOCKET NO. 163-29 CIP | SERIAL NO. 10/634,606 |
| | APPLICANT Förster et al. | CONFIRMATION NO. Unassigned |
| | FILING DATE August 5, 2003 | GROUP Unassigned |

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
|---------------------|--|--------------------|----------|----------------|-------|--------------|-------------------------------|
| | | 4,986,127 | 1/22/91 | Shimada et al. | | | |
| | | 5,187,984 | 2/23/93 | Mosser et al. | | | |
| | | 5,259,248 | 11/9/93 | Ugai et al. | | | |
| | | 5,463,904 | 11/7/95 | Kalinoski | | | |
| | | 5,469,749 | 11/28/95 | Shimada et al. | | | |
| | | 5,791,369 | 8/11/98 | Nishino et al. | | | |
| | | 5,820,262 | 10/13/98 | Lechner | | | |
| | | 5,868,159 | 2/9/99 | Loan et al. | | | |

FOREIGN PATENT DOCUMENTS

| EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUB CLASS | TRANSLATION | |
|---------------------|--|--------------------|---------|---------|-------|--------------|-------------|----|
| | | | | | | | YES | NO |
| | | JP 3-18735 | 1/28/91 | Japan | | | | |

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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|--|--|--|--|
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| | | | |

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication with applicant.